## FAIRCHILD

SEMICONDUCTOR

# FGA30N60LSD

### Features

- + Low saturation voltage:  $V_{CE(sat)}$  =1.1V @  $I_C$  = 30A
- High Input Impedance
- Low Conduction Loss

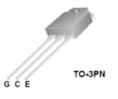
### Applications

- Solar Inverters
- UPS, Welder



### **General Description**

The FGA30N60LSD is a MOS gated high voltage switching device combining the best features of MOSFETs and bipolar transistors. This device has the high input impedance of a MOSFET and the low on-state conduction loss of a bipolar transistor.





### **Absolute Maximum Ratings**

Symbol	Description           Collector-Emitter Voltage		FGA30N60LSD	Units V	
V <sub>CES</sub>			600		
V <sub>GES</sub>	Gate-Emitter Voltage		± 20	V	
I <sub>C</sub>	Collector Current	@ $T_{C} = 25^{\circ}C$	60	А	
	Collector Current	@ T <sub>C</sub> = 100°C	30	А	
I <sub>CM (1)</sub>	Pulsed Collector Current		90	А	
I <sub>FSM</sub>	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave		150	А	
P <sub>D</sub>	Maximum Power Dissipation	@ T <sub>C</sub> = 25°C	480	W	
	Maximum Power Dissipation	@ T <sub>C</sub> = 100°C	192	W	
TJ	Operating Junction Temperature		-55 to +150	°C	
T <sub>stg</sub>	Storage Temperature Range		-55 to +150	°C	
Τ <sub>L</sub>	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C	

Notes :

(1) Repetitive rating : Pulse width limited by max. junction temperature

### **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Units
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction-to-Case		0.26	°C/W
R <sub>0JC</sub> (Diode) Thermal Resistance, Junction-to-Case			0.92	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction-to-Ambient		40	°C/W

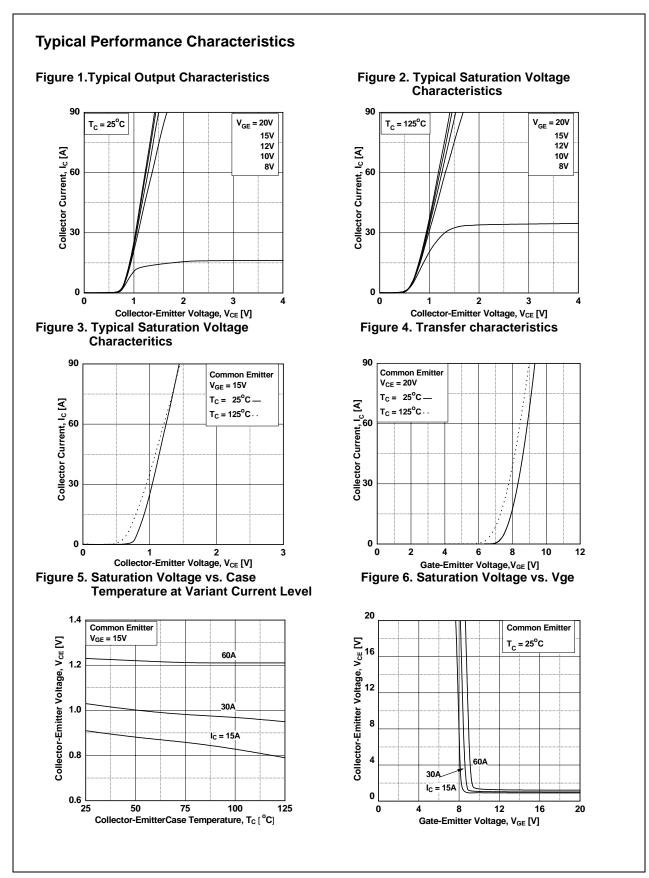
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October 2008

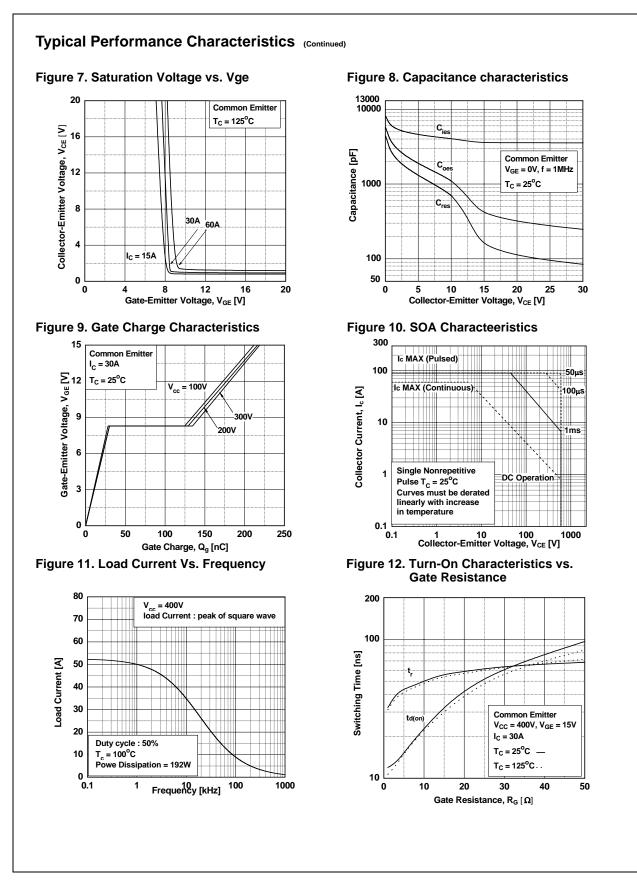
					Packaging			Max	x Qty
•		Device	Pa	ackage	Туре	Qtv pe	er Tube	per Box	
		TO-3PN Tube			)ea	-			
	00202								
Electric	al Cha	racteristics of	the I	<b>GBT</b> T <sub>C</sub> = 25	$^{\circ}\!$				
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Units
Off Charac	teristics								
BV <sub>CES</sub> Collector-Emitter Breakdown Voltage		$V_{GE} = 0V, I_C$	$V_{GE} = 0V, I_{C} = 250uA$				V		
ΔB <sub>VCES</sub> / ΔT <sub>J</sub>	Temperat Voltage	ure Coefficient of Break	kdown	$V_{GE} = 0V, I_{C} = 250uA$			0.6		V/∘C
I <sub>CES</sub>	Collector	Cut-Off Current		$V_{CE} = V_{CES}, V_{GE} = 0V$				250	uA
I <sub>GES</sub>	G-E Leak	age Current		$V_{GE} = V_{GES}, V_{CE} = 0V$				±250	nA
On Charac	teristics			,					
V <sub>GE(th)</sub>		shold Voltage		I <sub>C</sub> = 250uA, V <sub>CE</sub> = V <sub>GE</sub>		4.0	5.5	7.0	V
- (* )			I <sub>C</sub> = 30A, V <sub>GE</sub> = 15V			1.1	1.4	V	
V <sub>CE(sat)</sub> Collector to Emitter Saturation Voltage			$I_{C} = 30A, V_{GE} = 15V, T_{C} = 125^{\circ}C$			1.0		V	
			I <sub>C</sub> = 60 A, V <sub>C</sub>	<sub>GE</sub> = 15V		1.3		V	
Dynamic C	1						0550		-
C <sub>ies</sub>	Input Capacitance Output Capacitance Reverse Transfer Capacitance		V <sub>CE</sub> = 30V, V <sub>GE</sub> = 0V, f = 1MHz			3550		pF	
C <sub>oes</sub>						245		pF	
C <sub>res</sub>						90		pF	
Switching	Character	istics							
t <sub>d(on)</sub>	1	Delay Time					18		ns
t <sub>r</sub>	Rise Time	9					46		ns
t <sub>d(off)</sub>	Turn-Off	Delay Time		V <sub>CC</sub> = 400 V	. lc = 30A.		250		ns
t <sub>f</sub>	Fall Time			$R_G = 6.8\Omega$ , $V_{GE} = 15V$ , Inductive Load, $T_C = 25^{\circ}C$			1.3	2.0	us
E <sub>on</sub>	Turn-On	Switching Loss					1.1		mJ
E <sub>off</sub>	Turn-Off	Switching Loss					21		mJ
t <sub>d(on)</sub>	Turn-On	Delay Time					17		ns
t <sub>r</sub>	Rise Time	9		1			45		ns
t <sub>d(off)</sub>	Turn-Off	Delay Time		V <sub>CC</sub> = 400 V	, I <sub>C</sub> = 30A,		270		ns
t <sub>f</sub>	Fall Time Turn-On Switching Loss		R <sub>G</sub> =6.8Ω, V <sub>GE</sub> = 15V,			2.6		us	
E <sub>on</sub>			Inductive Loa	Inductive Load, T <sub>C</sub> = 125°C		1.1		mJ	
E <sub>off</sub>	Turn-Off	Switching Loss		1			36		mJ
Qg	Total Gate	e Charge					225		nC
	Gate-Emitter Charge		$V_{CE} = 300 \text{ V}, I_{C} = 30\text{ A},$			30		nC	
Q <sub>ge</sub>	Cato Lini			V <sub>GE</sub> = 15V					
Q <sub>ge</sub> Q <sub>gc</sub>		lector Charge		V <sub>GE</sub> = 15V			105		nC

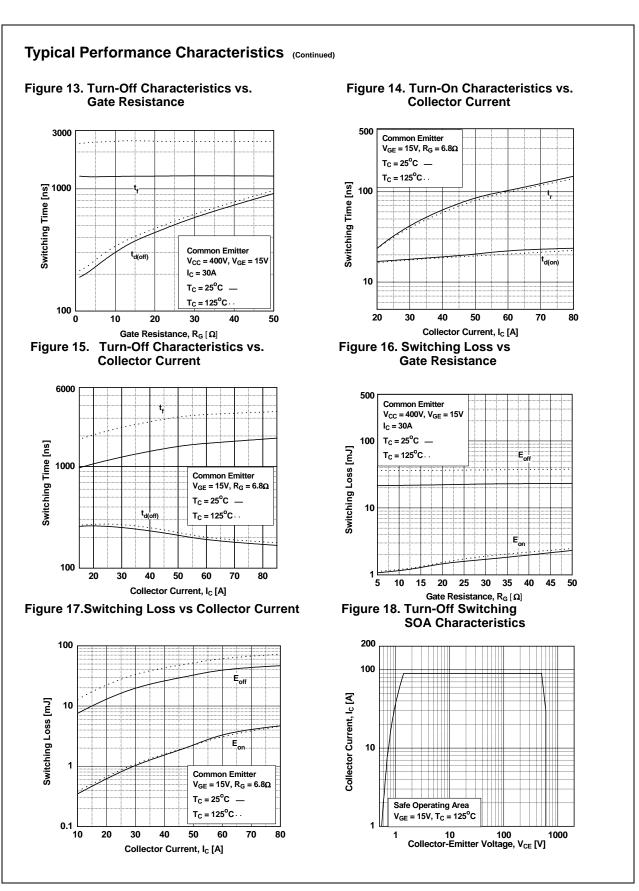
Parameter	Conditions	Conditions		Тур.	Max	Units
V <sub>FM</sub>	I <sub>F</sub> = 15A	T <sub>C</sub> = 25 °C T <sub>C</sub> = 125 °C	-	1.8	2.2	V
	I <sub>F</sub> = 15A	T <sub>C</sub> = 125 °C	-	1.6	-	V
I <sub>RM</sub>	$V_R = 600V$	T <sub>C</sub> = 25 °C	-	-	100	μΑ
t <sub>rr</sub>	$I_F = 1A$ , di/dt = 100A/µs, $V_{CC} = 30V$ $I_F = 15A$ , di/dt = 100A/µs, $V_{CC} = 390V$	T <sub>C</sub> = 25 °C T <sub>C</sub> = 25 °C	-	-	35 40	ns ns
t <sub>a</sub>	I <sub>F</sub> =15A, di/dt = 100A/µs, V <sub>CC</sub> = 390V	$T_{C} = 25 °C$ $T_{C} = 25 °C$ $T_{C} = 25 °C$ $T_{C} = 25 °C$	-	18	-	ns
t <sub>b</sub>		T <sub>C</sub> = 25 °C	-	13	-	ns
Q <sub>rr</sub>		T <sub>C</sub> = 25 °C	-	27.5	-	nC

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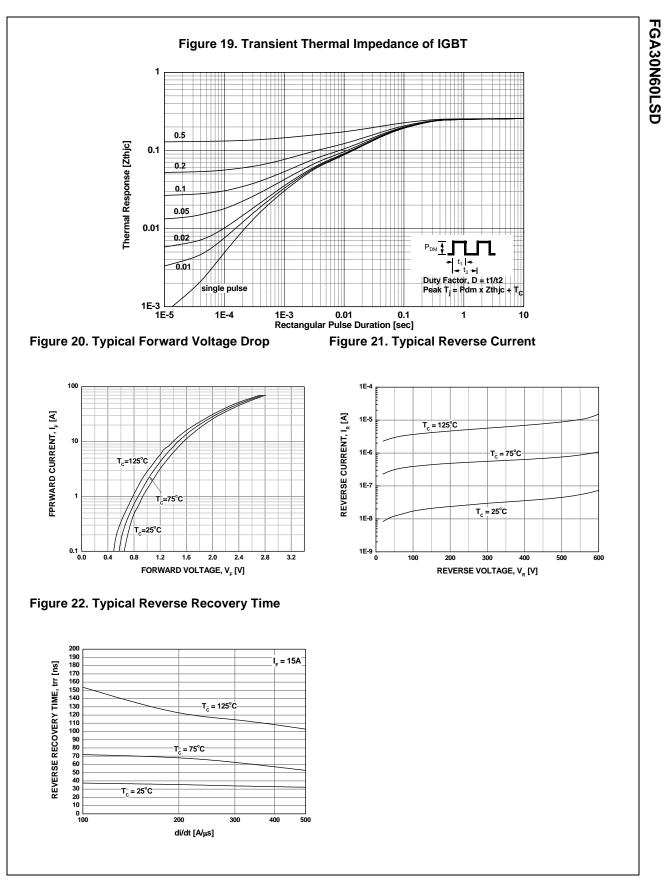


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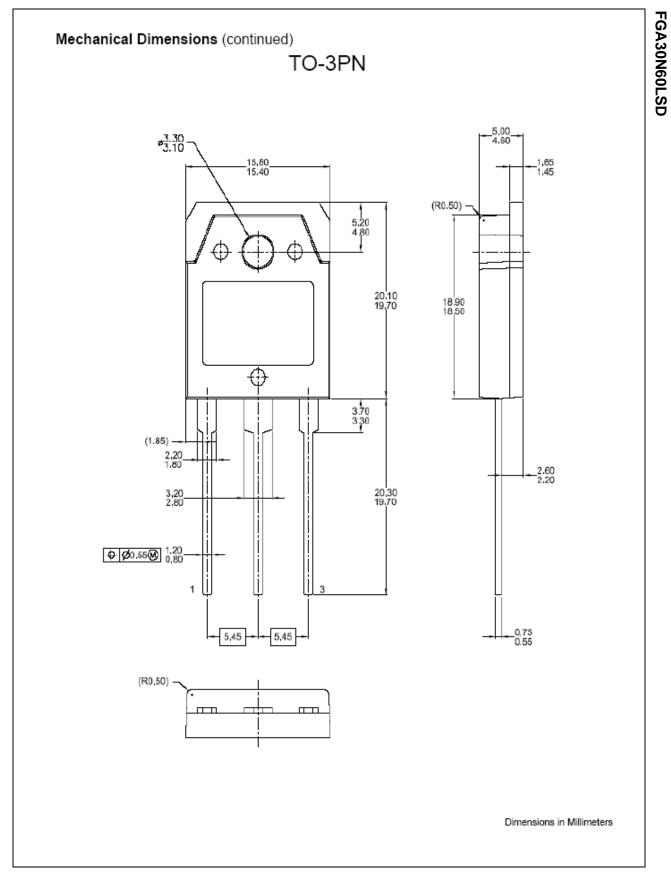




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